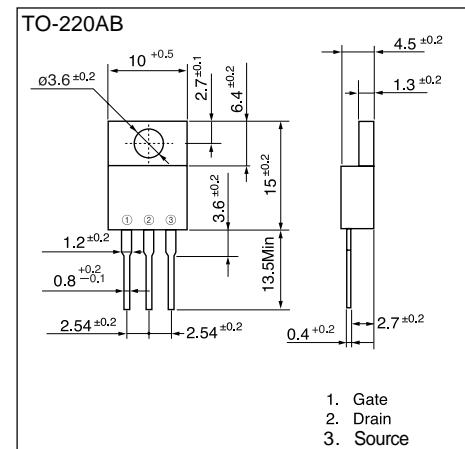


N-CHANNEL SILICON POWER MOS-FET**■ Features**

- High speed switching**
- Low on-resistance**
- No secondary breakdown**
- Low driving power**
- Avalanche-proof**

■ Applications

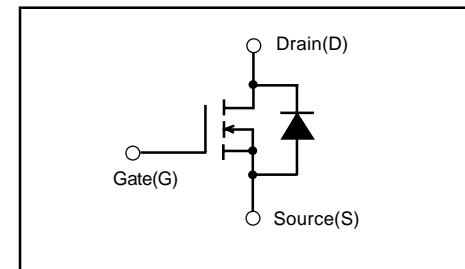
- Switching regulators**
- UPS (Uninterruptible Power Supply)**
- DC-DC converters**

**■ Maximum ratings and characteristic Absolute maximum ratings**

● (Tc=25°C unless otherwise specified)

Item	Symbol	Rating	Unit
Drain-source voltage	VDS	150	V
Continuous drain current	Id	±40	A
Pulsed drain current	Id(puls)	±160	A
Gate-source voltage	VGS	±30	V
Maximum Avalanche Energy	EAV ^{*1}	387	mJ
Max. power dissipation	Ta=25°C Pd	1.67	W
	Tc=25°C Pd	135	W
Operating and storage temperature range	Tch Tstg	+150 -55 to +150	°C

*1 L=420μH, Vcc=24V

■ Equivalent circuit schematic

● Electrical characteristics (Tc =25°C unless otherwise specified)

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V(BR)DSS	Id=1mA VGS=0V	150			V
Gate threshold voltage	VGS(th)	Id=1mA VDS=VGS	2.5	3.0	3.5	V
Zero gate voltage drain current	Idss	VDS=150V VGS=0V	1 0.1	100 0.5	100 mA	μA
Gate-source leakage current	IGSS	VGS=±30V VDS=0V	10	100	100	nA
Drain-source on-state resistance	RDS(on)	Id=20A VGS=10V	37	43	43	mΩ
Forward transconductance	gfs	Id=20A VDS=25V	12.5	25.0	25.0	S
Input capacitance	Ciss	VDS=25V	2650	3980		
Output capacitance	Coss	VGS=0V	550	830		pF
Reverse transfer capacitance	Crss	f=1MHz	240	360		
Turn-on time ton	td(on) tr	Vcc=48V Id=40A VGS=10V	21 95	32 142		
Turn-off time toff	td(off) tr	Rgs=10Ω	115	173		ns
Avalanche capability	Iav	L=100μH Tch=25°C	40			A
Diode forward on-voltage	VSD	If=40A VGS=0V Tch=25°C		0.97	1.46	V
Reverse recovery time	trr	If=40A VGS=0V		180		ns
Reverse recovery charge	Qrr	-di/dt=100A/μs Tch=25°C		1.30		μC

● Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	Rth(ch-c)	channel to case			0.93	°C/W
	Rth(ch-a)	channel to ambient			75.0	°C/W

■ Characteristics

